

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT4957299

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SHOU-JEN YANG	05/03/2016
MINH H NGUYEN	05/06/2016
JUI LIN CHEN	05/03/2016
RECEIVING PARTY DATA	
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Street Address:	11445 COMPAQ CENTER DRIVE WEST
City:	HOUSTON
State/Country:	TEXAS
Postal Code:	77070
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15775518
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Address Line 2:	MAIL STOP 79
Address Line 4:	FORT COLLINS, COLORADO 80528
ATTORNEY DOCKET NUMBER:	90603864
NAME OF SUBMITTER:	DEBORAH HIGHAM
SIGNATURE:	/Deborah Higham/
DATE SIGNED:	05/11/2018
Total Attachments: 6	
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Hewlett Packard Enterprise
3404 E. Harmony Road
Mail Stop 79
Fort Collins, Colorado 80526

PATENT APPLICATION

RECORD ID: 90128389

ASSIGNMENT OF PATENT APPLICATION

I/We, the undersigned (each), for good and valuable consideration, the receipt of which is hereby acknowledged, and in furtherance of my/our obligations to Hewlett Packard Enterprise Development LP, a Texas Limited Partnership having its principal place of business in Houston, Texas, (hereinafter HPED), and to its subsidiaries and affiliates, agree to assign and transfer and hereby assign and transfer to HPED, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Patent entitled:

TOOL-LESS ASSEMBLING OF ELECTRONIC BOARD ON CHASSIS

Filing Date: _____ Application No.: _____

and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part (C-I-P's), divisionals, and renewals of and substitutes for said application for said Patent, and any and all other Patent of any countries thereto which may be granted thereon or therefore; and any reissues, or reexaminations, or extensions of said Patent.

I/we additionally authorize HPED to file applications in my/our name for Patent in any country, to be held and enjoyed by HPED, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made;

AND I/we hereby covenant that I/we have full right to convey the entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Patent, to HPED, its successors, assigns, nominees or legal representatives, and I/we agree to communicate to HPED, or to its nominee, all known facts respecting said invention(s) or improvement(s), said application and said Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, C-I-P's, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything possible to aid HPED, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvement(s) in any and all countries provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by HPED;

AND I/we hereby authorize and request the official of any country or countries whose duty it is to issue patents on applications as aforesaid, to issue to HPED, as assignee of the entire right, title and interest, any and all Patent for said invention(s) or improvement(s) which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this assignment.

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IN WITNESS WHEREOF, I/we hereunto set my/our hand(s) and seal(s):

Shou Jen
Inventor's Signature

Yang

2016.5.3.
Date

Shou-Jen
First/Middle Name

Yang
Last Name

Inventor's Signature

Date

Minh H
First/Middle Name

Nguyen
Last Name

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3404 E. Harmony Road
Mail Stop 79
Fort Collins, Colorado 80528

PATENT APPLICATION

RECORD ID: 90128389

ASSIGNMENT OF PATENT APPLICATION (cont.)

Investor's Signature _____ Date _____

Jui Lin _____ Chen _____
First/Middle Name Last Name

Inventor's Signature _____ Date _____

First/Middle Name Last Name

Inventor's Signature _____ Date _____

First/Middle Name Last Name

Inventor's Signature _____ Date _____

First/Middle Name Last Name

Inventor's Signature _____ Date _____

First/Middle Name Last Name

Inventor's Signature _____ Date _____

First/Middle Name Last Name

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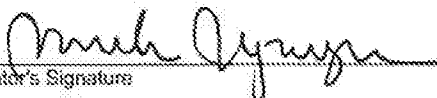
IN WITNESS WHEREOF, I/we hereunto set my/our hand(s) and seal(s):

Inventor's Signature

Date

Shou-Jen Yang

First/Middle Name Last Name



Inventor's Signature

5/6/2016

Date

Minh H Nguyen

First/Middle Name Last Name

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RECORD ID: 90128389

ASSIGNMENT OF PATENT APPLICATION (cont.)

Inventor's Signature Date

Jui Lin Chen

First/Middle Name Last Name

Inventor's Signature Date

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Inventor's Signature Date

Shou-Jen Yang

First/Middle Name Last Name

Inventor's Signature Date

Minh H Nguyen

First/Middle Name Last Name

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Mail Stop 79
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PATENT APPLICATION

RECORD ID: 90128389

ASSIGNMENT OF PATENT APPLICATION (cont.)

Jui Lin Chen 2016.5.3
Inventor's Signature Date

Jui Lin Chen
First/Middle Name Last Name

Inventor's Signature Date

First/Middle Name Last Name

Inventor's Signature Date

First/Middle Name Last Name

Inventor's Signature Date

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